

**WORLD TRADE ORGANIZATION**

Centre William Rappard  
Rue de Lausanne 154  
Case postale  
CH - 1211 Genève 21

Téléphone: (41 22) 739 51 11  
Ligne directe: (41 22) 739 52 52  
Téléfax: (41 22) 731 42 06  
Télex: 412 324 OMC/WTO CH  
Télégramme: OMC/WTO, GENÈVE

Référence: WLI/101

15 August 1997

**MARRAKESH AGREEMENT ESTABLISHING  
THE WORLD TRADE ORGANIZATION  
DONE AT MARRAKESH ON 15 APRIL 1994**

**GENERAL AGREEMENT ON TARIFFS AND TRADE 1994**

**CERTIFICATION OF MODIFICATIONS TO SCHEDULE XIV - NORWAY**

**TRANSMISSION OF CERTIFIED TRUE COPY**

I have the honour to furnish herewith a certified true copy of the Certification of Modifications to Schedule XIV - Norway, dated 2 July 1997.

R. Ruggiero  
Director-General

**SCHEDULES OF TARIFF CONCESSIONS TO THE  
GENERAL AGREEMENT ON TARIFFS AND TRADE 1994**

**CERTIFICATION OF MODIFICATIONS**

**SCHEDULE XIV - NORWAY**

WHEREAS the CONTRACTING PARTIES to the General Agreement on Tariffs and Trade 1947 adopted, on 26 March 1980, a Decision on Procedures for Modification and Rectification of Schedules of Tariff Concessions (BISD 27S/25);

WHEREAS in accordance with the provisions of the above-mentioned Decision, a draft containing modifications to Schedule XIV - Norway was communicated to all Members of the World Trade Organization in document G/MA/TAR/RS/15 on 2 April 1997;

IT IS HEREBY CERTIFIED that the modifications to Schedule XIV - Norway are established in conformity with the above-mentioned Decision.

The annexed modifications shall become effective on 2 July 1997.

This Certification is deposited with the Director-General of the World Trade Organization, who shall promptly furnish a certified true copy to each Member of the World Trade Organization. It shall be registered in accordance with the provisions of Article 102 of the Charter of the United Nations.

DONE at Geneva this second day of July, one thousand nine hundred and ninety-seven.

R. Ruggiero

Certified true copy:

Director-General

## **SCHEDULE XIV - NORWAY**

### **Modifications**

**2 July 1997**

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
	Bindings at 7-digit level							
3818	Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics.							
3818000	-Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics	6,7%	0	2000	WT/Let	G/67		0
7017	Laboratory, hygienic or pharmaceutical glassware, whether or not graduated or calibrated							
701710	-Of fused quartz or other fused silica							
ex7017100	-Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	0,16	0	1999	WT/Let	G/67		0
8419	Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilising, pasteurising, steaming, drying, evaporating, vaporising, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non-electric							
ex8419890	--Chemical vapor deposition apparatus for semiconductor production	4,3%	0	2000	WT/Let	G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
					<u>INR</u>	<u>GATT Schedule</u>		
ex8419900	-Parts of chemical vapor deposition apparatus for semiconductor production, including printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.	1,9%	0	1999	WT/Let	G/67		0
8421	Centrifuges, including centrifugal dryers; filtering or purifying machinery and apparatus, for liquids or gases.							
842119	-Centrifuges, including centrifugal dryers:							
	--Other							
ex8421199	---Spin dryers for semiconductor wafer processing	2,5%	0	1999	WT/Let	G/67		0
842191	-Parts:							
	--Of centrifuges, including centrifugal dryers							
ex8421919	---Parts of spin dryers for semiconductor wafer processing	4,3%	0	2000	WT/Let	G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8424	Mechanical appliances (whether or not hand-operated) for projecting, dispersing or spraying liquids or powders; fire extinguishers, whether or not charged; spray guns and similar appliances; steam or sand blasting machines and similar jet projecting machines.							
	-Other appliances:							
842489	--Other				WT/Let	G/67		0
ex:8424890	---Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	4,3%	0	2000				
ex:8424890	---Spraying appliances for etching, stripping or cleaning semiconductor wafers	4,3%	0	2000	WT/Let	G/67		0
842490	-Parts							
ex:8424909	--Parts of spraying appliances for etching, stripping or cleaning semiconductor wafers, including printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard.	4,3%	0	2000	WT/Let	G/67		0
	Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes.								
845610	-Operated by laser or other light or photon beam processes				WT/Let		G/67		0
ex8456100	--Machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	5,1%	0	2000					
	-Other:								
ex8456910	--Apparatus for stripping or cleaning semiconductor wafers	5,1%	0	2000	WT/Let		G/67		0
8456910	--For dry-etching patterns on semiconductor materials	5,1%	0	2000	WT/Let		G/67		0
845699	--Other								
ex8456990	---Focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	5,1%	0	2000	WT/Let		G/67		0
ex8456990	---Lasercutters for cutting contacting tracks in semiconductor production by laser beam	5,1%	0	2000	WT/Let		G/67		0
8464	Machine-tools for working stone, ceramics, concrete, asbestos-cement or like mineral materials or for cold working glass.								
ex846410	-Sawing machines								
ex8464100	-Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	5,5%	0	2000	WT/Let		G/67		0
846420	-Grinding or polishing machines								
ex8464200	--Grinding, polishing and lapping machines for processing of semiconductor wafers	5,5%	0	2000	WT/Let		G/67		0
846490	-Other								

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8464900	--Dicing machines for scribing or scoring semiconductor wafers	5,5%	0	2000	WT/Let	G/67		0
8466	Parts and accessories suitable for use solely or principally with the machines of headings Nos. 84.56 to 84.65, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine-tools; tool holders for any type of tool for working in the hand.							
	-Other:							
846691	--For machines of heading No. 84.64; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.							
ex8466910	---Parts of machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	3,3%	0	2000	WT/Let	G/67		0
ex8466910	---Parts of dicing machines for scribing or scoring semiconductor wafers	3,3%	0	2000	WT/Let	G/67		0
ex8466910	---Parts of grinding, polishing and lapping machines for processing of semiconductor wafers	3,3%	0	2000	WT/Let	G/67		0



<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
846693	--For machines of headings Nos. 84.56 to 84.61, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.								
ex8466930	---Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	3,3%	0	2000	WT/Let		T/51		0
ex8466930	---Parts of laser cutters for cutting contacting tracks in semiconductor production by laser beam	3,3%	0	2000	WT/Let		T/51		0
ex8466930	---Parts of machines for working any material by removal of photo beam in the production of semiconductor wafers	3,3%	0	2000	WT/Let		T/51		0
ex8466930	---Parts of apparatus for stripping or cleaning semiconductor wafers	3,3%	0	2000	WT/Let		T/51		0
ex8466930	---Parts of machines for dry-etching patterns on semiconductor materials	3,3%	0	2000	WT/Let		T/51		0
8469	Typewriters other than printers of heading No. 84.71; word-processing machines. -Automatic typewriters and word-processing machines:								

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Concession first incorporated in a	Earlier INRs	ODCs
8469110	--Word-processing machines	2,7%	0	2000	WT/Let		G/47		0	
8470	Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers.									
8470100	-Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions	3,3%	0	2000	WT/Let		G/47		0	
	-Other electronic calculating machines:									
8470210	--Incorporating a printing device	3,3%	0	2000	WT/Let		G/47		0	
8470290	--Other	3,3%	0	2000	WT/Let		G/47		0	
8470300	-Other calculating machines	2,7%	0	2000	WT/Let		G/47		0	
8470400	-Accounting machines	3,3%	0	2000	WT/Let		G/47		0	
8470500	-Cash registers	3,3%	0	2000	WT/Let		G/47		0	
847090	-Other									
8470901	--Postage-franking machines	2,7%	0	2000	WT/Let		G/47		0	
8470909	--Other	3,3%	0	2000	WT/Let		G/47		0	
8471	Automatic data processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included.									

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8471100-90	Computers: automatic data processing machines capable of 1) storing the processing program or programs and at least the data immediately necessary for the execution of the program; 2) being freely programmed in accordance with the requirements of the user; 3) performing arithmetical computations specified by the user; and 4) executing, without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run. The agreement covers such automatic data processing machines whether or not they are able to receive and process with the assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine, and not otherwise specified under Attachment A or B, are not covered by this agreement.		see below					
8471100	-Analogue or hybrid automatic data processing machines	3,4%	0	2000	WTT/Let	G/67		0
8471300	-Portable digital automatic data processing machines, weighing no more than 10 kg, consisting of at least a central processing unit, a keyboard and a display	3,4%	0	2000	WTT/Let	G/67		0
	-Other digital automatic data processing machines:							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
						<u>GATT Schedule</u>		
8471410	--Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined	3.4%	0	2000	WT/Let	G/67		0
8471490	--Other, presented in the form of systems	3.4%	0	2000	WT/Let	G/67		0
8471500	-Digital processing units other than those of subheadings 8471.41 and 8471.49, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units; including Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof; plotters	3.4%	0	2000	WT/Let	G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8471600	-Input or output units, whether or not containing storage units in the same housing including Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof; Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement, The agreement does not, therefore, cover televisions, including high definition televisions; Plotters; Projection type flat panel display units used with automatic data processing machines which can display digital information generated by the central processing unit; Proprietary format storage devices including media therefor for automatic data processing	3,4%	0	2000	WT/Let		G/67		0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8471700	<p>machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.</p> <p>-Storage units; including optical disc storage units, for automatic data processing machines (including CD drives and DVD-drives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings.; Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.</p>	3.4%	0	2000	WT/Let	G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8471800	-Other units of automatic data processing machines; including Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof; Authentication units for data processing machines (ciphering machines).	3,4%	0	2000	WT/Let	G/67		0
8471900	-Other	3,4%	0	2000	WT/Let	G/67		0
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin-counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines).							
847290	-Other							
ex8472909	--Automatic teller machines	4,3%	0	2000	WT/Let	G/67		0
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of headings Nos. 84.69 to 84.72.							

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs	Concession first incorporated in a
ex8473100	-Parts and accessories of the machines of heading 8469, being printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.	3,3%	0	2000	WT/Let		G/67		0	
8473210	-Parts and accessories of the machines of heading No. 84.70: --Of the electronic calculating machines of subheading No. 8470.10, 8470.21 or 8470.29, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.	3,3%	0	2000	WT/Let		G/67		0	



<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODGs</u>
8473290	--Other, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.	3,3%	0	2000	WT/Let	G/67	0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8473300	-Parts and accessories of the machines of heading No. 84.71 including flat panel displays (including LCD, Electro Luminescence, Plasma and other technologies) for products falling within this agreement, and parts thereof; including Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing; machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof, parts of plotters; also Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and	3,3%	0	2000	WT/Let		G/67		0	

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs
	micro assemblies of heading 8542.; Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).								
ex8473400	-Parts and accessories of automatic teller machines	3,3%	0	2000	WT/Let		G/67		0
8473500	-Parts and accessories equally suitable for use with machines of two or more of the headings Nos. 84.69 to 84.72, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard.	3,3%	0	2000	WT/Let		G/67		0
8477	Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.								
ex8477100	Machinery for working rubber or plastics or for the manufacture of products from these materials, not specified or included elsewhere in this chapter	4,9%	0	2000	WT/Let		G/67		0
	--Encapsulation equipment for assembly of semiconductors								

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8477900	--Parts of encapsulation equipment for assembly of semiconductors	4,9%	0	2000	WT/let	G/67		0	
8479	Machines and mechanical appliances having individual functions, not specified or included elsewhere in this Chapter.								
ex8479500	--Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	4,9%	0	2000	WT/Let	G/67		0	
	-Other machines and mechanical appliances:								
847989	--Other								
ex8479890	---Apparatus for growing or pulling monocrystal semiconductor boules	4,9%	0	2000	WT/Let	T/51		0	
ex8479890	---Apparatus for wet etching, developing, stripping or cleaning semiconductor wafer and flat panel displays	4,9%	0	2000	WT/Let	T/51		0	
ex8479890	---Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	4,9%	0	2000	WT/Let	T/51		0	
ex8479890	---Encapsulation equipment for assembly of semiconductors	4,9%	0	2000	WT/Let	T/51		0	
ex8479890	---Epitaxial deposition machines for semiconductor wafers	4,9%	0	2000	WT/Let	T/51		0	
ex8479890	---Machines for bending, folding and straightening semiconductor leads	4,9%	0	2000	WT/Let	T/51		0	
ex8479890	---Spinners for coating photographic emulsions on semiconductor wafers	4,9%	0	2000	WT/Let	T/51		0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
847990	-Parts; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542							
ex:8479909	--Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	4,9%	0	2000	WT/Let	G/67	0	
ex:8479909	--Parts for spinners for coating photographic emulsions on semiconductor wafers;	4,9%	0	2000	WT/Let	G/67	0	
ex:8479909	--Parts of apparatus for growing or pulling monocrystal semiconductor boules	4,9%	0	2000	WT/Let	G/67	0	
ex:8479909	--Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafer and flat panel displays	4,9%	0	2000	WT/Let	G/67	0	
ex:8479909	--Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	4,9%	0	2000	WT/Let	G/67	0	
ex:8479909	--Parts of encapsulation equipment for assembly of semiconductors	4,9%	0	2000	WT/Let	G/67	0	
ex:8479909	--Parts of epitaxial deposition machines for semiconductor wafers	4,9%	0	2000	WT/Let	G/67	0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>
ex8479909	--Parts of machines for bending, folding and straightening semiconductor leads	4,9%	0	2000	WT/Let				G/67
8480	Moulding boxes for metal foundry; mould bases; moulding patterns; moulds for metal (other than ingot moulds), metal carbides, glass, mineral materials, rubber or plastics.								
848071	-Moulds for rubber or plastics:								
	--Injection or compression types								
ex8480710	---Injection and compression moulds for the manufacture of semiconductor devices	4,9%	0	2000	WT/Let				G/67
8504	Electrical transformers, static converters (for example, rectifiers) and inductors.								
850440	-Static converters								
ex8504401	--Rectifiers for automatic data processing machines and units thereof, and telecommunication apparatus	3,3%	0	2000	WT/Let				T/51
ex8504409	--Static converters for automatic data processing machines and units thereof, and telecommunication apparatus	2,7%	0	2000	WT/Let				T/51
850450	-Other inductors								
ex8504500	--Other inductors for power supplies for automatic data processing machines and units thereof, and telecommunication apparatus	4,9%	0	2000	WT/Let				T/51

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Concession first incorporated in a	Earlier INRs	ODCs
ex8504902	---Parts of static converters, being printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	3,3%	0	2000	WT/Let		T/51		0	
8514	Industrial or laboratory electric (including induction or dielectric) furnaces and ovens; other industrial or laboratory induction or dielectric heating equipment.									
851410	-Resistance heated furnaces and ovens									
ex8514101	--Foundry furnaces, resistance heated, for the manufacture of semiconductor devices on semiconductor wafers	0	0	1967	WT/Let		G/67		0	
ex8514109	--Other resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	3,8%	0	2000	WT/Let		G/67		0	
851420	-Induction or dielectric furnaces and ovens									
ex8514201	--Foundry furnaces, inductance or dielectric, for the manufacture of semiconductor devices on semiconductor wafers	0	0	1967	WT/Let		G/67		0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8514209	--Other inductance or dielectric furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	3,8%	0	2000	WT/Let		G/67		0	
851430	-Other furnaces and ovens									
ex8514301	--Other foundry furnaces, for the manufacture of semiconductor devices on semiconductor wafers	0	0	1967	WT/Let		G/67		0	
ex8514309	--Other furnaces and ovens, for the manufacture of semiconductor devices on semiconductor wafers	3,8%	0	2000	WT/Let		G/67		0	
851490	-Parts; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542									
ex8514901	--Parts of foundry furnaces of Headings No 8514 10 to No 8514 30	0	0	1967	WT/Let		G/67		0	
ex8514902	--Parts of other furnaces and ovens of Headings No 8514 10 to No 8514 30	3,8%	0	2000	WT/Let		G/67		0	
ex8515800	--Wire-bonder	3,9%	0	2000	WT/Let		G/67		0	
ex8515900	--Parts of wire-bonders	3,9%	0	2000	WT/Let		A/49		0	



HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs
8517	Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier-current line systems or for digital line systems; videophones.								
	-Telephone sets; videophones:								
8517110	--Line telephone sets with cordless handsets	0,53	0	1999	WT/Let		G/67	0	
8517190	--Other	0,53	0	1999	WT/Let		G/67	0	
	-Facsimile machines and teleprinters:								
8517210	--Facsimile machines	0,53	0	1999	WT/Let		G/67	0	
8517220	--Teleprinters	0,27	0	1999	WT/Let		G/67	0	
8517300	-Telephonic or telegraphic switching apparatus	0,53	0	1999	WT/Let		G/67	0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8517500	-Other apparatus, for carrier-current line systems or for digital line systems; including electric amplifiers when used as repeaters in line telephony products falling within this agreement; also Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542; Set top boxes which have a communication function: a	0,53	0	1999	WTT/Let		G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
-------------	--------------------	------------------	-------------------	-----------------------	---------------------------------------	------------	---	----------------------	---------------------	-------------

microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange.

8517800	-Other apparatus; including electric amplifiers when used as repeaters in line telephony products falling within this agreement; Set top boxes which have a communication function: a microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange; Data processing machines (encryptors) for digital line systems (ciphering machines)	0,53	0	1999	WT/Let	G/67	0		
---------	--	------	---	------	--------	------	---	--	--

851790

-Parts; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542

8517902	--Parts of teleprinters	0,27	0	1999	WT/Let	G/67	0		
---------	-------------------------	------	---	------	--------	------	---	--	--

8517909	--Other parts, including parts of electric amplifiers used as repeaters in line telephony products falling within this agreement	0,53	0	1999	WT/Let	G/67	0		
---------	--	------	---	------	--------	------	---	--	--

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs
8518	Microphones and stands therefor; loudspeakers, whether or not mounted in their enclosures; headphones, earphones and combined microphone/speaker sets; audio-frequency electric amplifiers; electric sound amplifier sets.								
851810	-Microphones and stands therefor	2,1%	0	2000	WT/Let		G/67		0
ex8518100	--Microphones having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 10 mm and a height not exceeding 3 mm, for telecommunication use; Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).								
ex8518210	-Loudspeakers, whether or not mounted in their enclosures: ---Single loudspeakers, mounted in their enclosures, as parts of Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).	7%	0	2000	WT/Let		G/47		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first</u> <u>incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8518220	---Multiple loudspeakers, mounted in the same enclosure as parts of Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).	7%	0	2000	WT/Let		G/47		0	
ex8518290	---Loudspeakers, without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 50 mm, for telecommunication use; for Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).	7%	0	2000	WT/Let		G/47		0	
851830	-Headphones, earphones and combined microphone/speaker sets									
ex8518300	--Line telephone handsets	2,1%	0	2000	WT/Let		G/67		0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Concession first</u> <u>incorporated in a</u>
851890	-Parts being Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.; also for Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).	7%	0	2000	WT/Let		G/47	0		
ex8518901	---Of loudspeakers and audio-frequency electric amplifiers									
ex8518909	---Other	2,1%	0	2000	WT/Let		G/67	0		
8520	Magnetic tape recorders and other sound recording apparatus, whether or not incorporating a sound reproducing device.									
8520200	-Telephone answering machines	7%	0	2000	WT/Let		SC/60	0		
8522	Parts and accessories suitable for use solely or principally with the apparatus of headings Nos. 8519 to 8521									

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Concession first incorporated in a	Earlier INRs	ODCs
ex8522900	--Of telephone answering machines as Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	0,30	0	1999	WT/Let		G/47			0
8523	Prepared unrecorded media for sound recording or similar recording of other phenomena, other than products of Chapter 37. -Magnetic tapes:									
8523110	--Of a width not exceeding 4 mm	0,28	0	1999	WT/Let		G/47			0
8523120	--Of a width exceeding 4 mm but not exceeding 6.5 mm	0,28	0	1999	WT/Let		G/47			0
8523130	--Of a width exceeding 6.5 mm	0,28	0	1999	WT/Let		G/47			0
8523200	-Magnetic discs (including Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units).	0,28	0	1999	WT/Let		G/47			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8523900	-Other (including Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units).	0,28	0	1999	WT/Let		G/47		0
8524	Records, tapes and other recorded media for sound or other similarly recorded phenomena, including matrices and masters for the production of records, but excluding products of Chapter 37.								
8524310	-Discs for laser reading systems: --For reproducing phenomena other than sound or image (including Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units) --Other	0	0	1988	WT/Let		G/47		0
852439									



<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8524390	--For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine (including Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units)	0	0	1988	WT/Let		G/47		0
8524400	-Magnetic tapes for reproducing phenomena other than sound or image	0	0	1988	WT/Let		G/47		0
8524910	-Other: --For reproducing phenomena other than sound or image (including Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units)	0	0	1988	WT/Let		G/47		0
852499	--Other								

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>
					<u>INR</u>	<u>GATT Schedule</u> <u>Earlier INRs</u> <u>ODCs</u>
ex8524990	---For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine (including Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units)	0	0	1988	WT/Let	G/47 0
8525	Transmission apparatus for radio-telephony, radio-telegraphy, radio-broadcasting or television, whether or not incorporating reception apparatus or sound recording or reproducing apparatus; television cameras; still image video cameras and other video camera recorders.					
852510	-Transmission apparatus					
8525101	--Transmission apparatus, also incorporating ciphering devices, other than apparatus for radio-broadcasting or television	3,3%	0	2000	WT/Let	G/67 0
8525200	-Transmission apparatus incorporating reception apparatus, also those including ciphering devices	3,6%	0	2000	WT/Let	G/67 0
852540	-Still image video cameras and other video camera recorders					
ex8525400	--Digital still image video cameras	3,6%	0	2000	WT/Let	G/67 0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8527	Reception apparatus for radio-telephony, radio-telegraphy or radio-broadcasting, whether or not combined, in the same housing, with sound recording or reproducing apparatus or a clock.								
852790	-Other apparatus								
ex8527900	--Portable receivers for calling, alerting or paging; paging alert devices	3,6%	0	2000	WT/Let		G/67		0
8528	Reception apparatus for television, whether or not incorporating radio-broadcast receivers or sound or video recording or reproducing apparatus; video-monitors and video projectors.								
8528300	- Video projectors	17,2%	0	2000	WT/Let		G/47		0
8529	Parts suitable for use solely or principally with the apparatus of headings Nos. 85.25 to 85.28.								
852910	-Aerials and aerial reflectors of all kinds; parts suitable for use therewith								
ex8529101	--Aerials or antennae of a kind used with apparatus for radio-telephony and radio-telegraphy	3%	0	2000	WT/Let		G/47		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
					<u>INR</u>	<u>GATT Schedule</u>		

852990 -Other; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542:

ex8529901	--Parts of: transmission apparatus other than apparatus for radio-broadcasting or television transmission apparatus incorporating reception apparatus, digital still image video cameras, portable receivers for calling, alerting or paging and paging alert devices	4,2%	0	2000	WT/Let	G/47		0
-----------	---	------	---	------	--------	------	--	---

8531 Electric sound or visual signalling apparatus (for example, bells, sirens, indicator panels, burglar or fire alarms), other than those of heading No. 85.12 or 85.30.

8531200	--Indicator panels incorporating liquid crystal devices (LCD) or light emitting diodes (LED) including flat panel displays for products falling within this agreement	3,6%	0	2000	WT/Let	G/67		0
---------	---	------	---	------	--------	------	--	---

ex8531800	-Flat panel displays (including Electro Luminescence, Plasma and other technologies) for products falling within this agreement	3,6%	0	2000	WT/Let	G/67		0
-----------	---	------	---	------	--------	------	--	---

853190 -Parts

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8531900	--Parts of apparatus of subheading 8531 20 and 8531 80 falling within this agreement	3,6%	0	2000	WT/Let		G/67		0
8532	Electrical capacitors, fixed, variable or adjustable (pre-set).								
8532100	-Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not less than 0.5 kvar (power capacitors)	3,3%	0	2000	WT/Let		G/47		0
	-Other fixed capacitors:								
8532210	--Tantalum	3,3%	0	2000	WT/Let		G/47		0
8532220	--Aluminium electrolytic	3,3%	0	2000	WT/Let		G/47		0
8532230	--Ceramic dielectric, single layer	3,3%	0	2000	WT/Let		G/47		0
8532240	--Ceramic dielectric, multilayer	3,3%	0	2000	WT/Let		G/47		0
8532250	--Dielectric of paper or plastics	3,3%	0	2000	WT/Let		G/47		0
8532290	--Other	3,3%	0	2000	WT/Let		G/47		0
8532300	-Variable or adjustable (pre-set) capacitors	3,3%	0	2000	WT/Let		G/47		0
8532900	-Parts	3,3%	0	2000	WT/Let		G/47		0
8533	Electrical resistors (including rheostats and potentiometers), other than heating resistors.								
8533100	-Fixed carbon resistors, composition or film types	4,3%	0	2000	WT/Let		G/47		0
	-Other fixed resistors:								
8533210	--For a power handling capacity not exceeding 20 W	4,3%	0	2000	WT/Let		G/47		0
8533290	--Other	4,3%	0	2000	WT/Let		G/47		0
	-Wirewound variable resistors, including rheostats and potentiometers:								
8533310	--For a power handling capacity not exceeding 20 W	4,3%	0	2000	WT/Let		G/47		0
8533390	--Other	4,3%	0	2000	WT/Let		G/47		0
8533400	-Other variable resistors, including rheostats and potentiometers	4,3%	0	2000	WT/Let		G/47		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8533900	-Parts	4,3%	0	2000	WT/Let		G/47		0
8534	Printed circuits.								
8534000	-Printed circuits	4,3%	0	2000	WT/Let		G/47		0
8536	Electrical apparatus for switching or protecting electrical circuits, or for making connections to or in electrical circuits (for example, switches, relays, fuses, surge suppressors, plugs, sockets, lamp-holders, junction boxes), for a voltage not exceeding 1,000 volts.								
853650	-Other switches								
ex8536501	--Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches) for telephone switchboards	0,54	0	1999	WT/Let		G/67		0
ex8536509	--Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches)-Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches), other	3,9%	0	2000	WT/Let		G/47		0
ex8536501	--Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts for telephone switchboards	0,54	0	1999	WT/Let		G/67		0
ex8536509	--Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts, other	3,9%	0	2000	WT/Let		G/47		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8536501	--Electromechanical snap-action switches for a current not exceeding 11 amps, for telephone switchboards	0,54	0	1999	WT/Let	G/67		0
ex8536509	--Electromechanical snap-action switches for a current not exceeding 11 amps, other	3,9%	0	2000	WT/Let	G/47		0
853669	-Lamp-holders, plugs and sockets:							
	--Other							
ex8536690	---Plugs and sockets for co-axial cables and printed circuits	3,3%	0	2000	WT/Let	G/67		0
853690	-Other apparatus							
ex8536901	--Wire grips and junction boxes	3,9%	0	2000	WT/Let	G/47		0
ex8536909	--Wafer probers	3,3%	0	2000	WT/Let	G/47		0
ex8536909	--Other connection and contact elements for wires and cables	3,3%	0	2000	WT/Let	G/47		0
ex8538909	--Parts for use solely or principally with the apparatus of heading No. 85.36, covered by the declaration	3,9%	0	2000	WT/Let	G/47		0
8540	Thermionic, cold cathode or photo-cathode valves and tubes (for example, vacuum or vapour gas-filled valves and tubes, mercury arc rectifying valves and tubes, cathode-ray tubes, television camera tubes).							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
>x8540110	--Tubes of the following Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions	0,05	0	1999	WT/Let		G/67		0
>x8540120	--Tubes of the following Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions	0,05	0	1999	WT/Let		G/67		0



HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Concession first incorporated in a	Earlier INRs	ODCs
ex8540200	-- Tubes of the following Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions	0,05	0	1999	WT/Let		G/67			0
ex8540400	-- Tubes of the following Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions	0,05	0	1999	WT/Let		G/67			0

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs
ex:8540500	--Tubes of the following Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions	0,05	0	1999	WT/Let		G/67		0
ex:8540600	--Tubes of the following Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement.	0,05	0	1999	WT/Let		G/67		0
8541	Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes; mounted piezo-electric crystals.								
8541100	-Diodes, other than photosensitive or light emitting diodes	10,8%	0	2000	WT/Let		G/67		0

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a		
							GATT Schedule	Earlier INRs	ODCs
	-Transistors, other than photosensitive transistors:								
8541210	--With a dissipation rate of less than 1 W	14,2%	0	2000	WT/Let		G/67		0
8541290	--Other	3,7%	0	2000	WT/Let		G/67		0
8541300	-Thyristors, diacs and triacs, other than photosensitive devices	3,2%	0	2000	WT/Let		G/67		0
8541400	-Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes	3,3%	0	2000	WT/Let		G/67		0
8541500	-Other semiconductor devices	1,8%	0	2000	WT/Let		G/67		0
8541600	-Mounted piezo-electric crystals	4,3%	0	2000	WT/Let		G/67		0
854190	-Parts								
8541901	--Parts of mounted piezo-electric crystals	4,3%	0	2000	WT/Let		G/67		0
8541909	--Other parts	0,54	0	1999	WT/Let		G/67		0
8542	Electronic integrated circuits and microassemblies.								
	-Monolithic digital integrated circuits:								
8542120	--Cards incorporating an electronic integrated circuit ("smart" cards)	0,10	0	2000	WT/Let		G/67		0
8542130	--Metal oxide semiconductors (MOS technology)	0,10	0	2000	WT/Let		G/67		0
8542140	--Circuits obtained by bipolar technology	0,10	0	2000	WT/Let		G/67		0
8542190	--Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)	0,10	0	2000	WT/Let		G/67		0
8542300	-Other monolithic integrated circuits	0,10	0	2000	WT/Let		G/67		0
8542400	-Hybrid integrated circuits	0,10	0	2000	WT/Let		G/67		0
8542500	-Electronic microassemblies	0,10	0	2000	WT/Let		G/67		0
8542900	-Parts	1,36	0	2000	WT/Let		G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter.							
	-Particle accelerators:							
8543110	--Ion implanters for doping semiconductor materials	4,3%	0	2000	WT/Let	G/67		0
854330	-Machines and apparatus for electroplating, electrolysis or electrophoresis							
ex8543300	--Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	4,3%	0	2000	WT/Let	G/67		0
	-Other machines and apparatus:							
8543810	--Proximity cards and tags	4,3%	0	2000	WT/Let	G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs ODCs</u>
854389	--Other; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542; also Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards):						
ex8543890	---Electrical machines with translation or dictionary functions	4,3%	0	2000	WT/Let	G/67	0
ex8543890	---Apparatus for physical deposition by sputtering on semiconductor wafers; Plasmaspouter and such devices	4,3%	0	2000	WT/Let	G/67	0
ex8543890	---Physical deposition apparatus for semiconductor production	4,3%	0	2000	WT/Let	G/67	0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
854390	-Parts; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542:							
ex8543900	--Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	4,3%	0	2000	WT/Let	G/67		0
ex8543900	--Parts of ion implanters for doping semiconductor materials	4,3%	0	2000	WT/Let	G/67		0
ex8543900	--Parts of apparatus for physical deposition by sputtering on semiconductor wafers	4,3%	0	2000	WT/Let	G/67		0
ex8543900	--Parts of physical deposition apparatus for semiconductor production	4,3%	0	2000	WT/Let	G/67		0
8544	Insulated (including enamelled or anodised) wire, cable (including coaxial cable) and other insulated electric conductors, whether or not fitted with connectors: optical fibre cables, made up of individually sheathed fibres, whether or not assembled with electric conductors or fitted with connectors.							
	-Other electric conductors, for a voltage not exceeding 80 V:							
854441	--Fitted with connectors							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex8544410	---Other electric conductors, for a voltage not exceeding 80 V, fitted with connectors, of a kind used for telecommunications	0,48	0	2000	WT/Let		G/67		0	
854449	--Other									
ex8544490	---Other electric conductors, for a voltage not exceeding 80 V, not fitted with connectors, of a kind used for telecommunications	0,48	0	2000	WT/Let		G/67		0	
854451	-Other electric conductors, for a voltage exceeding 80 V but not exceeding 1,000 V:									
	--Fitted with connectors									
ex8544510	---Other electric conductors, for a voltage exceeding 80 V but not exceeding 1000 V, fitted with connectors, of a kind used for telecommunications	0,48	0	2000	WT/Let		G/67		0	
8544700	-Optical fibre cables	0	0	1988	WT/Let		G/67		0	
8548	Waste and scrap of primary cells, primary batteries and electric accumulators; spent primary cells, spent primary batteries and spent electric accumulators; electrical parts of machinery or apparatus, not specified or included elsewhere in this chapter.									

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs	Concession first incorporated in a
ex8548900	Electrical parts of machinery or apparatus falling within the agreement, not specified or included elsewhere in this chapter, in the form of Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	3,3%	0	2000	WT/Let		G/67		0	
9009	Photo-copying apparatus incorporating an optical system or of the contact type and thermo-copying apparatus. -Electrostatic photo-copying apparatus:									
9009110	--Operating by reproducing the original image directly onto the copy (direct process)	6,1%	0	2000	WT/Let		G/67		0	
9009210	--Other photo-copying apparatus: --Incorporating an optical system	2,1%	0	2000	WT/Let		G/67		0	



HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Concession first incorporated in a	Earlier INRs	ODCs
9009900	-Parts and accessories; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	6,1%	0	2000	WT/Let		G/67		0	
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials), not specified or included elsewhere in this Chapter; negatoscopes; projection screens. -Apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials:									
9010410	--Direct write-on-wafer apparatus	2,5%	0	2000	WT/Let		G/67		0	
9010420	--Step and repeat aligners	2,5%	0	2000	WT/Let		G/67		0	
9010490	--Other	2,5%	0	2000	WT/Let		G/67		0	

HS96    Description    Base rate    Bound rate    Implementation    Present concession established    Concession first incorporated in a    Earlier INRs    ODCs

901090	-Parts and accessories, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	2,5%	0	2000	WT/Let	G/67	0	
ex9010900	--Parts and accessories of the apparatus of Headings No 9010 41 to 9010 49							
9011	Compound optical microscopes, including those for photomicrography, cinematography or microprojection							
ex9011100	--Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	2,5%	0	2000	WT/Let	PSC4/55	0	
ex9011200	--Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	2,5%	0	2000	WT/Let	PSC4/55	0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first</u> <u>incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex9011900	--Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	2,5%	0	2000	WT/Let		PSC4/55		0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex9011900	--Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	2,5%	0	2000	WT/Let		PSC4/55		0
9012	Microscopes other than optical microscopes; diffraction apparatus								
ex9012100	--Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	2,5%	0	2000	WT/Let		G/67		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex9012900	--Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	2,5%	0	2000	WT/Let		G/67		0	
9013	Liquid crystal devices not constituting articles provided for more specifically in other headings; lasers, other than laser diodes; other optical appliances and instruments, not specified or included elsewhere in this chapter									
ex9013200	--Flat panel displays (including LCD, Electro Luminescence, Plasma and other technologies) for products falling within this agreement	2%	0	2000	WT/Let		G/67		0	
ex9013800	--Flat panel displays (including LCD, Electro Luminescence, Plasma and other technologies) for products falling within this agreement	2%	0	2000	WT/Let		G/67		0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex9013900	--Parts of flat panel displays (including LCD, Electro Luminescence, Plasma and other technologies) for products falling within this agreement; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	2%	0	2000	WT/Let		G/67	0	
9017	Drawing, marking-out or mathematical calculating instruments (for example, drafting machines, pantographs, protractors, drawing sets, slide rules, disc calculators); instruments for measuring length, for use in the hand (for example, measuring rods and tapes, micrometers, callipers), not specified or included elsewhere in this chapter								
ex9017100	--Plotters	3,6%	0	2000	WT/Let		T/51	0	
ex9017200	--Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates; Plotters	2,1%	0	2000	WT/Let		T/51	0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex9017900	--Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	3,8%	0	2000	WT/Let		G/47		0
ex9017900	--Parts of such pattern generating apparatus, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	3,8%	0	2000	WT/Let		G/47		0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs ODCs</u>
9026	Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading No. 90.14, 90.15, 90.28 or 90.32.						
902610	-For measuring or checking the flow or level of liquids						
9026101	--Electrical	7,6%	0	2000	WT/Let	T/51	0
9026109	--Other	4,6%	0	2000	WT/Let	G/56	0
902620	-For measuring or checking pressure						
9026201	--Electrical	12,4%	0	2000	WT/Let	G/56	0
9026209	--Other	5,3%	0	2000	WT/Let	G/56	0
902680	-Other instruments or apparatus						
9026801	--Electrical	7,6%	0	2000	WT/Let	G/56	0
9026809	--Other	4,6%	0	2000	WT/Let	G/56	0
9026900	-Parts and accessories, including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard.	4,6%	0	2000	WT/Let	G/56	0
	Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542						



HS96      Description      Base rate      Bound rate      Implementation      Present      Concession first  
INR      INR      INR      INR      concession      incorporated in a  
Established      GATT Schedule      Earlier INRs      ODCs

9027      Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes.

902720      -Chromatographs and electrophoresis instruments

9027201      --Electrical      8,2%      0      2000      WT/Let      G/56      0

9027209      --Other      0      0      1967      WT/Let      G/56      0

902730      -Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)

9027301      --Electrical      8,2%      0      2000      WT/Let      G/56      0

9027309      --Other      0      0      1967      WT/Let      G/56      0

902750      -Other instruments and apparatus using optical radiations (UV, visible, IR)

9027501      --Electrical      8,2%      0      2000      WT/Let      G/56      0

9027509      --Other      0      0      1967      WT/Let      G/56      0

902780      -Other instruments and apparatus

9027801      --Electrical      8,2%      0      2000      WT/Let      G/56      0

9027809      --Other      0      0      1967      WT/Let      G/56      0

902790      -Microtomes; parts and accessories

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
ex9027900	--Parts and accessories of products of heading 9027, other than for gas or smoke analysis apparatus and microtomes; Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard, is included. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	0	0	1967	WT/Let	G/56		0
9030	Oscilloscopes, spectrum analysers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading No. 90.28; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionising radiations.							
9030400	--Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)	8,2%	0	2000	WT/Let	G/56		0
9030820	--Other instruments and apparatus:							
	--For measuring or checking semiconductor wafers or devices	8,2%	0	2000	WT/Let	G/56		0
903090	--Parts and accessories							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a</u>	
		<u>5,2%</u>	<u>0</u>	<u>2000</u>	<u>INR</u>	<u>GATT Schedule</u>	
						<u>Earlier INRs</u>	
						<u>ODCs</u>	
ex9030909	--Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542				WT/Let	G/56	0
ex9030909	--Parts of instruments and appliances for measuring or checking semiconductor wafers or devices; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	5,2%	0	2000	WT/Let	G/56	0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this Chapter; profile projectors.								
	-Other optical instruments and appliances:								
9031410	--For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	5.2%	0	2000	WT/Let		G/67	0	
903149	--Other								
ex9031490	---Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	5.2%	0	2000	WT/Let		G/67	0	
903190	-Parts and accessories								
ex9031900	--Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	5.2%	0	2000	WT/Let		G/67	0	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u> <u>INR</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u> <u>Earlier INRs</u> <u>ODCs</u>
ex9031900	--Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers; including Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542	5,2%	0	2000	WT/Let	G/67 0

## Norway

26 March 1997

With respect to any product described in or for Attachment B to the Annex to the Ministerial Declaration on Trade in Information Technology Products (WT/MIN(96)/16), to the extent not specifically provided for in this Schedule, the customs duties on such product, as well as any other duties and charges of any kind (within the meaning of Article II:1(b) of the General Agreement on Tariffs and Trade 1994), shall be bound and eliminated, as set forth in paragraph 2(a) of the Annex to the Declaration, wherever the product is classified.

<u>Description</u>	<u>HS</u>
Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	7017100
Chemical vapor deposition apparatus for semiconductor production	8419890
Parts of chemical vapor deposition apparatus for semiconductor production.	8419900
Apparatus for stripping or cleaning semiconductor wafers	8456910
Lasercutters for cutting contacting tracks in semiconductor production by laser beam	8456990
Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	8464100
Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	8466910
Parts of dicing machines for scribing or scoring semiconductor wafers	8466910
Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam	8466930
Parts of apparatus for stripping or cleaning semiconductor wafers	8466930
Encapsulation equipment for assembly of semiconductors	8477100
Parts of encapsulation equipment	8477900
Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	8479500
Apparatus for physical deposition by sputtering on semiconductor wafers	8543890
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	8479890
Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors; Wire-bonders and parts thereof	8479890, 8515800, 8515900
Encapsulation equipment for assembly of semiconductors	8479890
Machines for bending, folding and straightening semiconductor leads	8479890

HSDescription

Physical deposition apparatus for semiconductor production	8543890
Spinners for coating photographic emulsions on semiconductor wafers	8479890
Part of apparatus for physical deposition by sputtering on semiconductor wafers	8543900
Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	8479909
Parts for spinners for coating photographic emulsions on semiconductor wafers	8479909
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	8479909
Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	8479909
Parts of encapsulation equipment for assembly of semiconductors	8479909
Parts of machines for bending, folding and straightening semiconductor leads	8479909
Parts of physical deposition apparatus for semiconductor production	8543900
Apparatus for rapid heating of semiconductor wafers	8514301, 8514309
Parts of apparatus for rapid heating of wafers	8514901, 8514902
Wafer probers	8536909
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	8543300
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	8543900
Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	9011100
Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	9011200
Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	9011900

Description

HS

-Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	9011900
Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	9012100
Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	9012900
Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	9017200
Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	9017900
Parts of such pattern generating apparatus	9017900
Computers: automatic data processing machines capable of 1) storing the processing program or programs and at least the data immediately necessary for the execution of the program; 2) being freely programmed in accordance with the requirements of the user; 3) performing arithmetical computations specified by the user; and 4) executing, without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run. The agreement covers such automatic data processing machines whether or not they are able to receive and process with the assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine, and not otherwise specified under Attachment A or B, are not covered by this agreement.	8471100, 8471300, 8471410, 8471490, 8471500, 8471600, 8471700, 8471800, 8471900
Electric amplifiers when used as repeaters in line telephony products falling within this agreement, and parts thereof	8517500, 8517800, 8517909, 8543200
Flat panel display devices (including LCD, Electro Luminescence, Plasma, Vacuum-Fluorescence and other technologies) for products falling within this agreement, and parts thereof.	8473210, 8473290, 8473300, 8473500, 8531200, 8531800, 8531900, 9013200, 9013800, 9013900
Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof.	8471500, 8471600, 8471800, 8517800



Description

HS

Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions.	8471600, 8540110, 8540120, 8540200, 8540400, 8540500, 8540600
Optical disc storage units, for automatic data processing machines (including CD drives and DVD-drives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings.	8471700
Paging alert devices, and parts thereof	8527900, 8529901
Plotters whether input or output units of HS heading No 8471 or drawing or drafting machines of HS heading No 9017.	8471500, 8471600, 8473300, 9017100, 9017200
Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.	8419900, 8424909, 8466910, 8466930, 8473100, 8473210, 8473290, 8473300, 8473400, 8473500, 8479909, 8504902, 8514901, 8514902, 8517500, 8517902, 8517909, 8518901, 8518909, 8522900, 8529901, 8531900, 8538909, 8543890, 8543900, 8548900, 9009900, 9010900, 9011900, 9012900, 9013900, 9017900, 9026900, 9027900, 9030909, 9031900
Projection type flat panel display units used with automatic data processing machines which can display digital information generated by the central processing unit.	8471600, 8528300
Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.	8471600, 8471700, 8523200, 8523900, 8524310, 8524390, 8524910, 8524990
Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).	8473300, 8518100, 8518210, 8518220, 8518290, 8518901, 8518909, 8543890
Set top boxes which have a communication function: a microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange	8517500, 8517800

## Norway

26 March 1997

ex HS	Base rate	July 1997	1998	1999	2000	2001	2002	2003	2004	2005
3818000	6,7%	5,0%	3,1%	1,5%	0					
ex 7017100	0,16	0,12	0,04	0						
ex 8419890	4,3%	3,2%	1,8%	0,7%	0					
ex 8419900	1,9%	1,4%	0,4%	0						
ex 8421199	2,5%	1,8%	0,6%	0						
ex 8421919	4,3%	3,2%	1,8%	0,7%	0					
ex 8424890	4,3%	3,2%	1,8%	0,7%	0					
ex 8424890	4,3%	3,2%	1,8%	0,7%	0					
ex 8424909	4,3%	3,2%	1,8%	0,7%	0					
ex 8456100	5,1%	3,8%	2,5%	1,2%	0					
ex 8456910	5,1%	3,8%	2,5%	1,2%	0					
ex 8456990	5,1%	3,8%	2,5%	1,2%	0					
ex 8464100	5,5%	3,8%	2,5%	1,2%	0					
ex 8464200	5,5%	4,1%	2,6%	1,2%	0					
ex 8464900	5,5%	4,1%	2,6%	1,2%	0					
ex 8466910	3,3%	2,4%	1,6%	0,7%	0					
ex 8466930	3,3%	2,4%	1,6%	0,7%	0					
ex 8466930	3,3%	2,4%	1,6%	0,7%	0					
ex 8466930	3,3%	2,4%	1,6%	0,7%	0					
8469110	2,7%	2,0%	1,2%	0,5%	0					
8470100	3,3%	2,4%	1,6%	0,7%	0					
8470210	3,3%	2,4%	1,6%	0,7%	0					
8470290	3,3%	2,4%	1,6%	0,7%	0					
8470300	2,7%	2,0%	1,2%	0,5%	0					
8470400	3,3%	2,4%	1,6%	0,7%	0					
8470500	3,3%	2,4%	1,6%	0,7%	0					
8470901	2,7%	2,0%	1,2%	0,5%	0					
8470909	3,3%	2,4%	1,6%	0,7%	0					
8471100	3,4%	2,5%	1,6%	0,7%	0					
8471300	3,4%	2,5%	1,6%	0,7%	0					
8471410	3,4%	2,5%	1,6%	0,7%	0					
8471490	3,4%	2,5%	1,6%	0,7%	0					
8471500	3,4%	2,5%	1,6%	0,7%	0					
8471600	3,4%	2,5%	1,6%	0,7%	0					
8471700	3,4%	2,5%	1,6%	0,7%	0					

ex HS	Base rate	July 1997	1998	1999	2000	2001	2002	2003	2004	2005
8471800	3,4%	2,5%	1,6%	0,7%	0					
8471900	3,4%	2,5%	1,6%	0,7%	0					
ex 8472909	4,3%	3,2%	1,8%	0,7%	0					
ex 8473100	3,3%	2,4%	1,6%	0,7%	0					
8473210	3,3%	2,4%	1,6%	0,7%	0					
8473290	3,3%	2,4%	1,6%	0,7%	0					
8473300	3,3%	2,4%	1,6%	0,7%	0					
ex 8473400	3,3%	2,4%	1,6%	0,7%	0					
8473500	3,3%	2,4%	1,6%	0,7%	0					
ex 8477100	4,9%	3,6%	2,2%	1,0%	0					
ex 8477900	4,9%	3,6%	2,2%	1,0%	0					
ex 8479500	4,9%	3,6%	2,2%	1,0%	0					
ex 8479890	4,9%	3,6%	2,2%	1,0%	0					
ex 8479890	4,9%	3,6%	2,2%	1,0%	0					
ex 8479909	4,9%	3,6%	2,2%	1,0%	0					
ex 8479909	4,9%	3,6%	2,2%	1,0%	0					
ex 8480710	4,9%	3,6%	2,2%	1,0%	0					
ex 8504401	3,3%	2,4%	1,6%	0,7%	0					
ex 8504409	2,7%	2,0%	1,2%	0,5%	0					
ex 8504500	4,9%	3,6%	2,2%	1,0%	0					
ex 8504902	3,3%	2,4%	1,6%	0,7%	0					
ex 8514101	0									
ex 8514109	3,8%	2,8%	1,7%	0,8%	0					
ex 8514201	0									
ex 8514209	3,8%	2,8%	1,7%	0,8%	0					
ex 8514301	0									
ex 8514309	3,8%	2,8%	1,7%	0,8%	0					
ex 8514901	0									
ex 8514902	3,8%	2,8%	1,7%	0,8%	0					
ex 8515800	3,9%	2,9%	1,7%	0,7%	0					
ex 8515900	3,9%	2,9%	1,7%	0,7%	0					
8517110	0,53	0,39	0,13	0						
8517190	0,53	0,39	0,13	0						
8517210	0,53	0,39	0,07	0						
8517220	0,27	0,20	0,07	0						
8517300	0,53	0,39	0,13	0						
8517500	0,53	0,39	0,13	0						

HS	Base rate	July 1997	1998	1999	2000	2001	2002	2003	2004	2005
8517800	0,53	0,39	0,13	0						
8517902	0,27	0,20	0,07	0						
8517909	0,53	0,39	0,13	0						
ex 8518100	2,1%	1,5%	1,0%	0,5%	0					
ex 8518210	7,0%	5,2%	3,0%	1,2%	0					
ex 8518220	7,0%	5,2%	3,0%	1,2%	0					
ex 8518290	7,0%	5,2%	3,0%	1,2%	0					
ex 8518300	2,1%	1,5%	1,0%	0,5%	0					
ex 8518901	7,0%	5,2%	3,0%	1,2%	0					
ex 8518909	2,1%	1,5%	1,0%	0,5%	0					
8520200	7,0%	5,2%	3,0%	1,2%	0					
ex 8522900	0,30	0,22	0,07	0						
8523110	0,28	0,21	0,07	0						
8523120	0,28	0,21	0,07	0						
8523130	0,28	0,21	0,07	0						
8523200	0,28	0,21	0,07	0						
8523900	0,28	0,21	0,07	0						
8524310	0									
ex 8524390	0									
8524400	0									
8524910	0									
ex 8524990	0									
8525101	3,3%	2,4%	1,4%	0,6%	0					
8525200	3,6%	2,7%	1,6%	0,7%	0					
ex 8525400	3,6%	2,7%	1,6%	0,7%	0					
ex 8527900	3,6%	2,7%	1,6%	0,7%	0					
8528300	17,2%	12,9%	7,8%	3,5%	0					
ex 8528101	3,0%	2,2%	1,2%	0,5%	0					
ex 8529901	4,2%	3,1%	2,0%	1,0%	0					
8531200	3,6%	2,7%	1,6%	0,7%	0					
ex 8531800	3,6%	2,7%	1,6%	0,7%	0					
ex 8531900	3,6%	2,7%	1,6%	0,7%	0					
8532100	3,3%	2,4%	1,6%	0,7%	0					
8532210	3,3%	2,4%	1,6%	0,7%	0					
8532220	3,3%	2,4%	1,6%	0,7%	0					
8532230	3,3%	2,4%	1,6%	0,7%	0					
8532240	3,3%	2,4%	1,6%	0,7%	0					

CA	HS	Base rate	July 1997	1998	1999	2000	2001	2002	2003	2004	2005
	8532250	3,3%	2,4%	1,6%	0,7%	0					
	8532290	3,3%	2,4%	1,6%	0,7%	0					
	8532300	3,3%	2,4%	1,6%	0,7%	0					
	8532900	3,3%	2,4%	1,6%	0,7%	0					
	8533100	4,3%	3,2%	1,8%	0,7%	0					
	8533210	4,3%	3,2%	1,8%	0,7%	0					
	8533290	4,3%	3,2%	1,8%	0,7%	0					
	8533310	4,3%	3,2%	1,8%	0,7%	0					
	8533390	4,3%	3,2%	1,8%	0,7%	0					
	8533400	4,3%	3,2%	1,8%	0,7%	0					
	8533900	4,3%	3,2%	1,8%	0,7%	0					
	8534000	4,3%	3,2%	1,8%	0,7%	0					
ex	8536501	0,54	0,40	0,13	0						
ex	8536509	3,9%	2,9%	1,7%	0,7%	0					
ex	8536501	0,54	0,40	0,13	0						
ex	8536690	3,3%	2,4%	1,3%	0,5%	0					
ex	8536901	3,9%	2,9%	1,7%	0,7%	0					
ex	8536909	3,3%	2,4%	1,3%	0,5%	0					
ex	8538909	3,9%	2,9%	1,7%	0,7%	0					
ex	8540110	0,05	0,03	0,01	0						
ex	8540120	0,05	0,03	0,01	0						
ex	8540200	0,05	0,03	0,01	0						
ex	8540400	0,05	0,03	0,01	0						
ex	8540500	0,05	0,03	0,01	0						
ex	8540600	0,05	0,03	0,01	0						
	8541100	10,8%	8,1%	4,9%	2,2%	0					
	8541210	14,2%	10,6%	5,8%	2,2%	0					
	8541290	3,7%	2,7%	1,7%	0,7%	0					
	8541300	3,2%	2,4%	1,5%	0,7%	0					
	8541400	3,3%	2,4%	1,5%	0,7%	0					
	8541500	1,8%	1,3%	0,8%	0,3%	0					
	8541600	4,3%	3,2%	1,8%	0,7%	0					
	8541901	4,3%	3,2%	1,8%	0,7%	0					
	8541909	0,54	0,40	0,13	0						
	8542120	0,10	0,07	0,05	0,02	0					
	8542130	0,10	0,07	0,05	0,02	0					
	8542140	0,10	0,07	0,05	0,02	0					

ex	HS	Base rate	July 1997	1998	1999	2000	2001	2002	2003	2004	2005
	8542190	0,10	0,07	0,05	0,02	0					
	8542300	0,10	0,07	0,05	0,02	0					
	8542400	0,10	0,07	0,05	0,02	0					
	8542500	0,10	0,07	0,05	0,02	0					
	8542900	1,36	1,02	0,68	0,30	0					
	8543110	4,3%	3,2%	1,8%	0,7%	0					
ex	8543300	4,3%	3,2%	1,8%	0,7%	0					
	8543810	4,3%	3,2%	1,8%	0,7%	0					
ex	8543890	4,3%	3,2%	1,8%	0,7%	0					
ex	8543900	4,3%	3,2%	1,8%	0,7%	0					
ex	8544410	0,48	0,36	0,12	0						
ex	8544490	0,48	0,36	0,12	0						
ex	8544510	0,48	0,36	0,12	0						
	8544700	0									
ex	8548900	3,3%	2,4%	1,6%	0,7%	0					
	9009110	6,1%	4,5%	3,0%	1,5%	0					
	9009210	2,1%	1,5%	1,0%	0,5%	0					
	9009900	6,1%	4,5%	3,0%	1,5%	0					
	9010410	2,5%	1,8%	1,1%	0,5%	0					
	9010420	2,5%	1,8%	1,1%	0,5%	0					
	9010490	2,5%	1,8%	1,1%	0,5%	0					
ex	9010900	2,5%	1,8%	1,1%	0,5%	0					
ex	9011100	2,5%	1,8%	1,1%	0,5%	0					
ex	9011200	2,5%	1,8%	1,1%	0,5%	0					
ex	9011900	2,5%	1,8%	1,1%	0,5%	0					
ex	9012100	2,5%	1,8%	1,1%	0,5%	0					
ex	9012900	2,5%	1,8%	1,1%	0,5%	0					
ex	9013200	2,0%	1,5%	1,0%	0,5%	0					
ex	9013800	2,0%	1,5%	1,0%	0,5%	0					
ex	9013900	2,0%	1,5%	1,0%	0,5%	0					
ex	9017100	3,6%	2,7%	1,6%	0,7%	0					
ex	9017200	2,1%	1,5%	1,0%	0,5%	0					
ex	9017900	3,8%	2,8%	1,7%	0,7%	0					
	9026101	7,6%	5,7%	2,9%	1,0%	0					
	9026109	4,6%	3,4%	2,1%	1,0%	0					
	9026201	12,4%	9,3%	4,1%	1,0%	0					
	9026209	5,3%	3,9%	2,3%	1,0%	0					

	2000	1999	2000	2001	2002	2003	2004	2005
9026801	7,6%	5,7%	2,9%	0	0	0	0	0
9026809	4,6%	3,4%	2,1%	0	0	0	0	0
9026900	4,6%	3,4%	2,9%	0	0	0	0	0
9027201	8,2%	6,1%	3,3%	0	0	0	0	0
9027209	0							
9027301	8,2%	6,1%	3,3%	0	0	0	0	0
9027309	0							
9027501	8,2%	6,1%	3,3%	0	0	0	0	0
9027509	0							
9027801	8,2%	6,1%	3,3%	0	0	0	0	0
9027809	0							
ex 9027900	0							
9030400	8,2%	6,1%	3,3%	0	0	0	0	0
9030820	8,2%	6,1%	3,3%	0	0	0	0	0
ex 9030909	5,2%	3,9%	2,5%	0	0	0	0	0
ex 9030909	5,2%	3,9%	2,5%	0	0	0	0	0
9031410	5,2%	3,9%	2,5%	0	0	0	0	0
ex 9031490	5,2%	3,9%	2,5%	0	0	0	0	0
ex 9031900	5,2%	3,9%	2,5%	0	0	0	0	0
ex 9031900	5,2%	3,9%	2,5%	0	0	0	0	0